To all our customers

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Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

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Keep safety first in your circuit designs!

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   Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

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2SC4500(L)/(S)

Silicon NPN Epitaxial

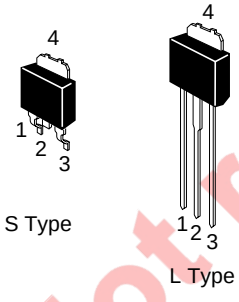
ADE-208-894 (Z)
1st. Edition
September 2000

Application

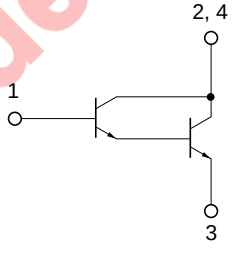
Low frequency amplifier

Outline

DPAK



1. Base
2. Collector
3. Emitter
4. Collector



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	60	V
Collector to emitter voltage	V_{CEO}	60	V
Emitter to base voltage	V_{EBO}	7	V
Collector current	I_C	1	A
Collector peak current	$I_{C\ (peak)}$	2	A
Collector power dissipation	P_C	0.8	W
	P_C*[1]	8	
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C

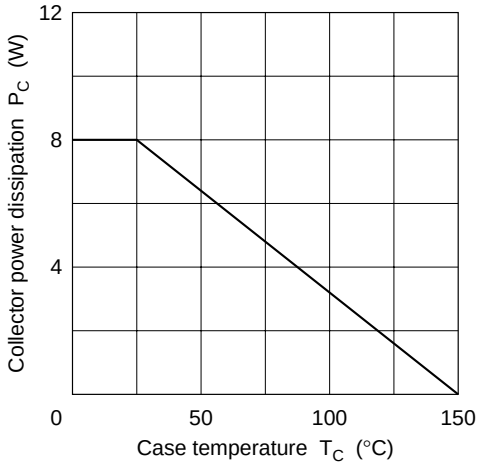
Note: 1. Value at T_C = 25°C.

Electrical Characteristics (Ta = 25°C)

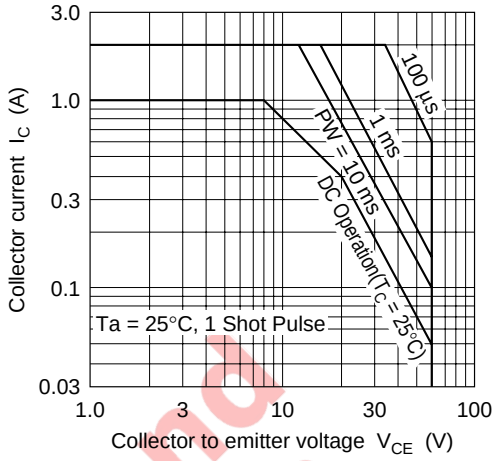
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	60	—	—	V	I_C = 1 mA, R_{BE} = ∞
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	—	—	V	I_E = 0.1 mA, I_C = 0
Collector cutoff current	I_{CBO}	—	—	10	µA	V_{CB} = 60 V, I_E = 0
DC current transfer ratio	h_{FE}	2000	—	—		V_{CE} = 10 V, I_C = 500 mA*[1]
Collector to emitter saturation voltage	$V_{CE\ (sat)}$	—	—	1.5	V	I_C = 500 mA, I_B = 0.5 mA*[1]
Base to emitter saturation voltage	$V_{BE\ (sat)}$	—	—	2.0	V	I_C = 500 mA, I_B = 0.5 mA*[1]
Turn on time	t_{on}	—	100	—	ns	V_{CC} = 12 V, IC = 250 mA,
Turn off time	t_{off}	—	600	—	ns	I_{B1} = –I_{B2} = 5 mA

Note: 1. Pulse Test.

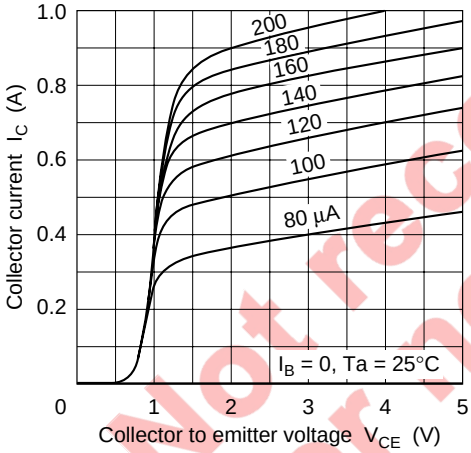
Maximum Collector Dissipation Curve



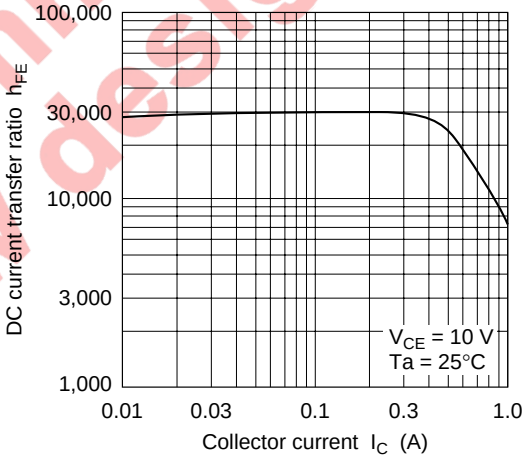
Area of Safe Operation

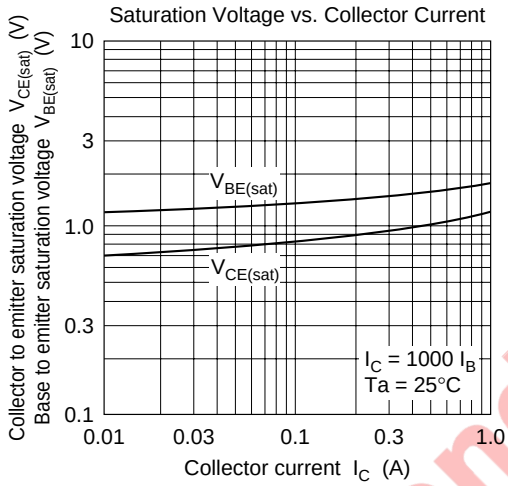


Typical Output Characteristics



DC Current Transfer Ratio vs. Collector Current





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